

# Silicon, Iron, and Copper Ions for RHIC

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## 1 Review Au and d Setup

Figures 1, 2, 3, 4, 5, 6, 7, 8

## 2 Silicon, Iron, Nickel, and Copper Parameters

Tables 1, 2, 3, 4, 5, 6

## References

- [1] C.J. Gardner, et al, “Status and Recent Performance of the Accelerators that Serve as Gold Injector for RHIC”, PAC01, Chicago (2001) 3326–3328.
- [2] L. A. Ahrens, et al, “The RHIC Injector Accelerator Configurations and Performance for the RHIC 2003 Au-d Physics Run”, PAC03, Portland, Oregon (2003) 1715–1717.
- [3] C.J. Gardner, “Booster, AGS, and RHIC Parameters for the 2003–2004 RHIC Run”, August 26, 2003.

### 3 Intensities

Currents of  $\text{Si}^{5+}$  as high as  $230 \mu\text{A}$  have been observed in the TTB line with the  $\text{Si}^-$  source running “flat out”, but typically the current is between 50 and  $100 \mu\text{A}$ . For  $\text{Si}^{5+}$  ions with 63.8 MeV kinetic energy at Booster injection, the revolution period is  $9.63 \mu\text{s}$ . Since experience has shown that no more than 45 turns can fit into the Booster acceptance, the maximum pulse width that can be accepted by Booster is then  $433 \mu\text{s}$ . Assuming a pulsed current of  $100 \mu\text{A}$  in the TTB line, one then has  $54 \times 10^9$  silicon ions available per Tandem pulse at Booster injection. Booster output/input is typically 50% or less. The maximum intensity available per Booster cycle would then be  $27 \times 10^9$  silicon ions.

Currents of  $\text{Fe}^{10+}$  in the TTB line are also typically between 50 and  $100 \mu\text{A}$ . These ions are transported down the TTB line at the same rigidity as  $\text{Si}^{5+}$ , and, since the charge-to-mass ratios of the two ions are nearly identical, the velocities are nearly identical. Assuming a pulsed current of  $100 \mu\text{A}$  and the same pulse width as for silicon, one then has  $27 \times 10^9$  iron ions available per Tandem pulse at Booster injection. With Booster output/input at 50%, a maximum of  $13.5 \times 10^9$  iron ions are available per Booster cycle.

Currents of  $\text{Cu}^{11+}$  in the TTB line are also expected to be between 50 and  $100 \mu\text{A}$ . The revolution period of these ions in Booster is  $9.22 \mu\text{s}$  which for 45 turns gives a pulse width of  $415 \mu\text{s}$ . At a current of  $100 \mu\text{A}$  one then has  $24 \times 10^9$  copper ions available per Tandem pulse at Booster injection. The maximum intensity available at extraction per Booster cycle would then be  $12 \times 10^9$  copper ions.

With the acceleration scheme used for the past several years, one Booster load ends up in one RHIC bunch and  $(\text{RHIC Input})/(\text{Booster Output})$  is typically at least 50%.

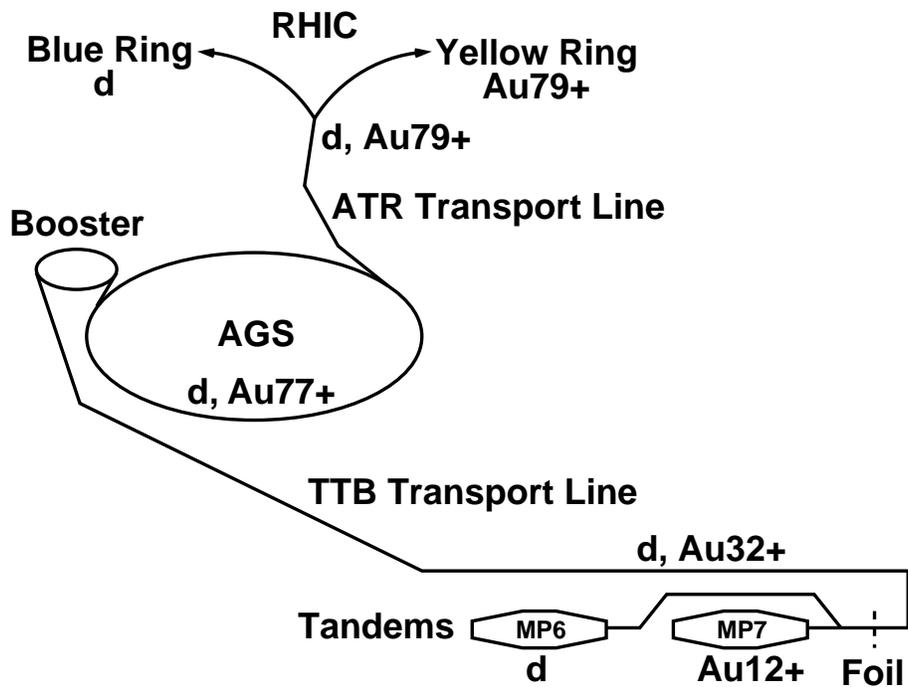


Figure 1: Acceleration of Gold Ions and Deuterons for RHIC

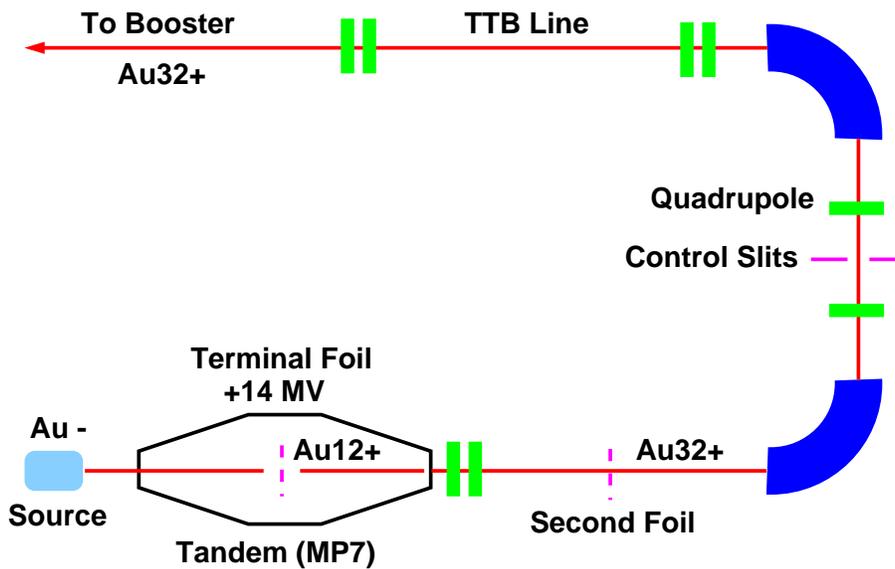


Figure 2: Gold Ions from Source through Tandem to TTB Line

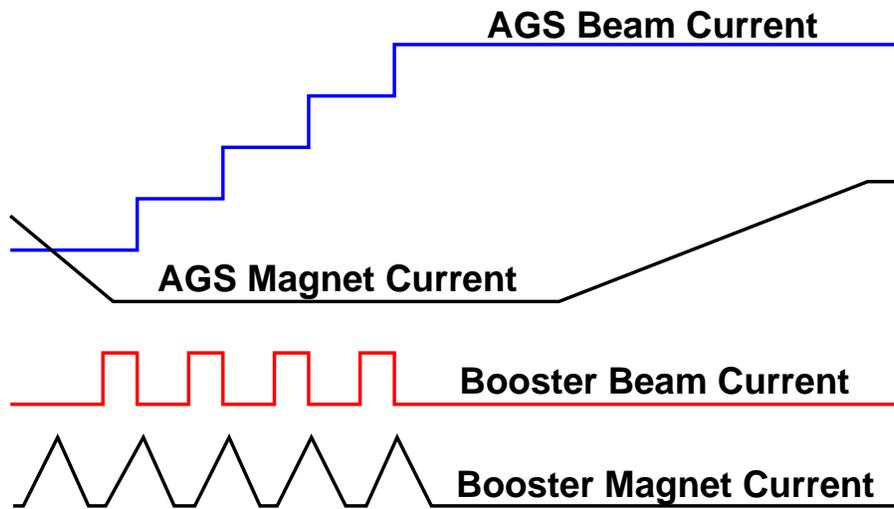


Figure 3: Timing of Booster and AGS Cycles

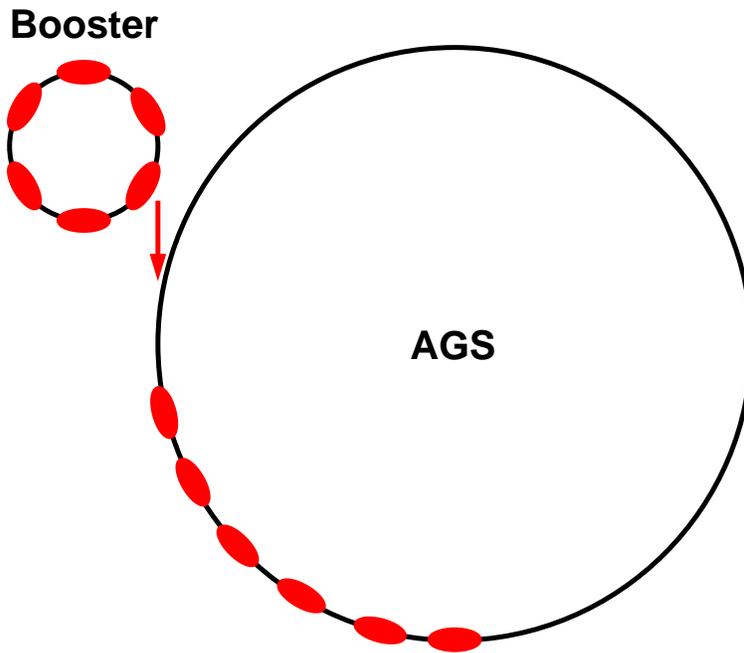


Figure 4: Transfer of One Booster Load to AGS

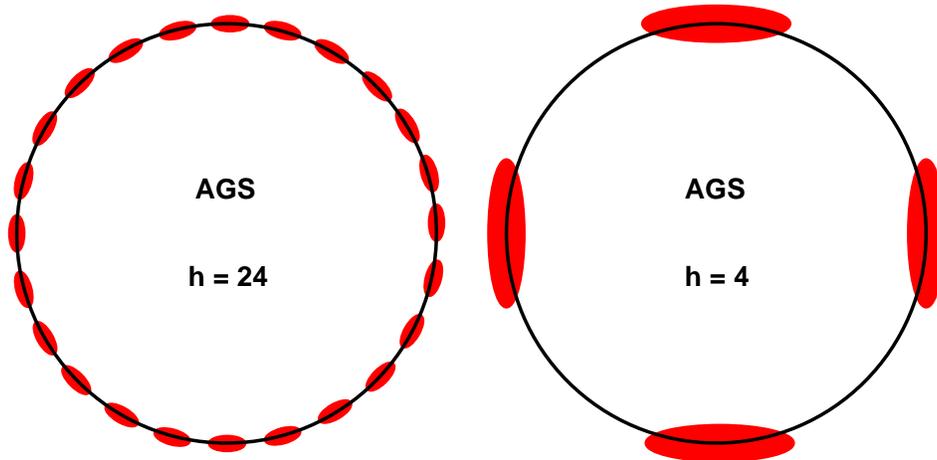


Figure 5: 24 Bunches Rebunched into Four

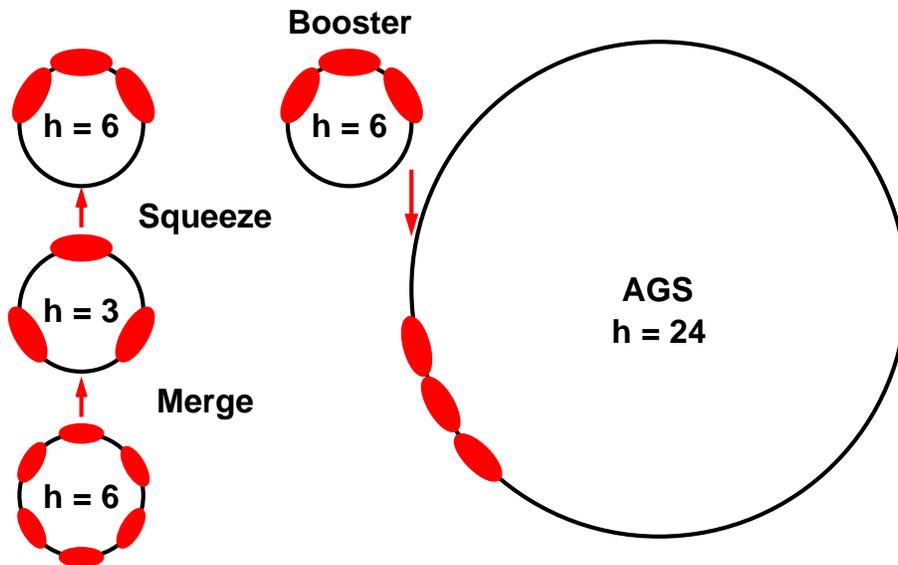


Figure 6: Booster Merge and Squeeze to Double Intensity per Bunch

Table 1: Tandem and Booster Injection Parameters

Ion	Tandem Voltage $V_T$ (MV)	Kinetic Energy $W$ (MeV)	Inflexor Voltage $V_I$ (kV)	Magnetic Rigidity $B\rho$ (Tm)	RF Harm $h$	Injection Frequency $hf$ (kHz)
Au <sup>32+</sup>	14.058	182.879	22.218	0.854085	6	397.740
d	8.636	17.3965	67.355	0.854085	2	401.922
Si <sup>5+</sup>	10.616	63.822	49.588	1.217428	6	622.770
Fe <sup>10+</sup>	11.838	127.687	49.604	1.217428	6	622.980
Ni <sup>10+</sup>	11.196	123.288	47.899	1.217428	6	601.567
Cu <sup>11+</sup>	13.046	156.675	55.327	1.300433	6	650.493

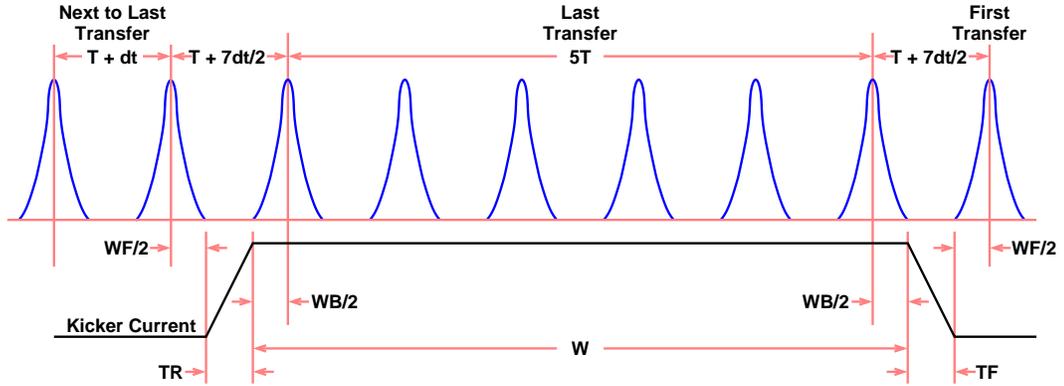


Figure 7: AGS Injection Kicker Timing for Transfer of One Booster Load. The kicker width is fixed; this fixes the Booster extraction frequency.

Table 2: Rigidities and Frequencies

Ion	$h$	Booster Injection $B\rho$ (Tm)	Booster Injection $hf$ (kHz)	Booster Extraction $B\rho$ (Tm)	Booster Extraction $hf$ (MHz)	AGS Injection $B\rho$ (Tm)
Au	6	0.854085	397.740	9.1360	3.842917	3.7216
d	2	0.854085	401.922	7.3224	2.259236	7.3224
Si <sup>5+</sup>	6	1.217428	622.770	8.323813	3.850	2.972266
Fe <sup>10+</sup>	6	1.217428	622.980	8.321000	3.850	3.199882
Ni <sup>10+</sup>	6	1.217428	601.567	8.618614	3.850	3.077552
Cu <sup>11+</sup>	6	1.300433	650.493	8.510510	3.850	3.227618

Table 3: Frequencies and Periods

Ion	$h$	Booster Injection $hf$ (kHz)	Booster Extraction $hf$ (MHz)	Revolution Period $1/f$ (ns)	Bunch Spacing $1/(hf)$ (ns)
Au	6	397.740	3.842917	1561.31	260.219
d	2	401.922	2.259236	885.255	442.627
Si <sup>5+</sup>	6	622.770	3.850	1558.44	259.740
Fe <sup>10+</sup>	6	622.980	3.850	1558.44	259.740
Ni <sup>10+</sup>	6	601.567	3.850	1558.44	259.740
Cu <sup>11+</sup>	6	650.493	3.850	1558.44	259.740

Table 4: Emittances assuming aperture filled to  $185\pi$  at Booster Injection

Ion	$h$	Booster Injection $\beta_0\gamma_0$	Booster Extraction $\beta\gamma$	Adiabatic Ratio $\beta_0\gamma_0/(\beta\gamma)$	BTA Emittance $\epsilon\pi$	Normalized Emittance $\epsilon_N\pi$
Au	6	0.0447	0.4777	0.0936	$17.3\pi$	$8.26\pi$
d	2	0.1365	1.1704	0.1166	$21.6\pi$	$25.3\pi$
Si <sup>5+</sup>	6	0.0700	0.4788	0.1462	$27.2\pi$	$13.0\pi$
Fe <sup>10+</sup>	6	0.0701	0.4788	0.1464	$27.2\pi$	$13.0\pi$
Ni <sup>10+</sup>	6	0.0676	0.4788	0.1412	$26.1\pi$	$12.5\pi$
Cu <sup>11+</sup>	6	0.0732	0.4788	0.1529	$28.3\pi$	$13.5\pi$

Table 5: Stationary Bucket Area at End of Capture (assuming 0.5 kV gap voltage at end of capture).

Here  $h \frac{A_S}{N} = 8 \frac{R_s}{c} \left\{ \frac{2}{\pi|\eta_s|} \right\}^{1/2} \left\{ \frac{E_s}{N} \right\}^{1/2} \left\{ \frac{Q}{Nh} \right\}^{1/2} \{eV_g\}^{1/2}$ .

Ion	$Q$	$N$	$h$	$\eta_s$	$E_s/N$	$Q/(Nh)$	$hA_S/N$
Au	32	197	6	-0.955	932.181	0.0271	0.0786
d	1	2	2	-0.938	946.505	0.2500	0.2428
Si <sup>5+</sup>	5	28	6	-0.952	932.915	0.0298	0.0826
Fe <sup>10+</sup>	10	56	6	-0.952	932.600	0.0298	0.0826
Ni <sup>10+</sup>	10	58	6	-0.952	932.493	0.0287	0.0811
Cu <sup>11+</sup>	11	63	6	-0.951	932.851	0.0291	0.0817

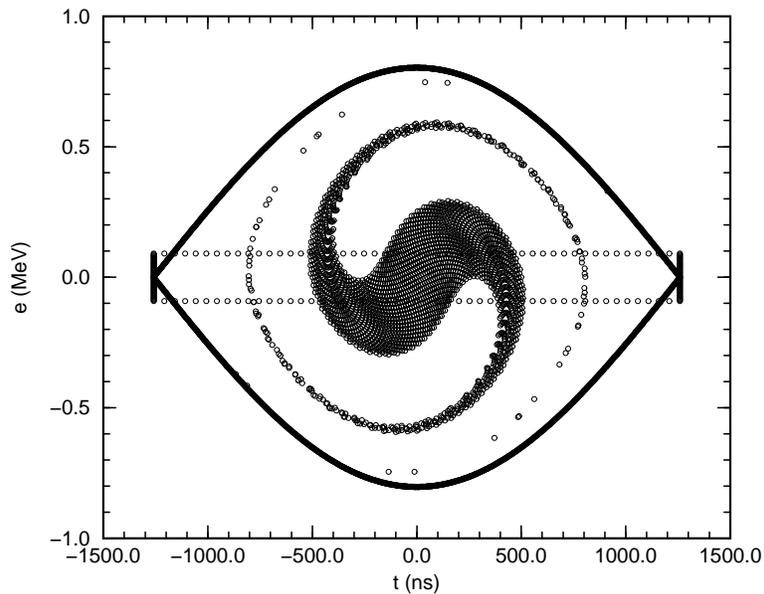


Figure 8:  $\text{Au}^{32+}$  distribution at end of RF capture in Booster. Here  $h = 6$ ,  $V_g = 0.5$  kV. The bucket area gives an upper limit on the longitudinal emittance in Booster.

Table 6: Longitudinal parameters for single bunch of gold ions (measured by J.M. Brennan). Six of these bunches become one RHIC bunch.

Parameter	Booster Extraction	After BTA Foil	After AGS Filamentation	Unit
$\epsilon$	0.045/6	$4 \times 0.045/6$	$6 \times 0.045/6$	eV-s/n
$\Delta t$	48	48	76	ns
$\Delta E$	20	76	76	MeV
$hf$	3.848719	3.848719	3.775458	MHz
$1/(hf)$	259.827	259.827	264.868	ns